19-1717: Rev 2: 5/03

Fast, Low-Voltage, 4Ω , 4-Channel CMOS Analog Multiplexer

General Description

The MAX4634 fast, low-voltage, 4-channel CMOS analog multiplexer features 4Ω (max) on-resistance (RON). It offers R_{ON} matching between switches to 0.3Ω (max) and RON flatness of 1Ω (max) over the specified signal range. Each switch can handle V+ to GND analog signals. Off-leakage current is only 0.1nA (max) at +25°C. The MAX4634 features fast turn-on (ton) and turn-off (toff) times of 18ns and 11ns, respectively. All this comes in the tiny 10-pin µMAX and 10-pin, 3mm x 3mm, thin QFN packages.

This low-voltage multiplexer operates from a +1.8V to +5.5V single supply. All digital inputs have +0.8V and +2.4V logic thresholds, ensuring TTL/CMOS-logic compatibility with +5V operation.

Applications

Battery-Operated Equipment Audio and Video Signal Routing Low-Voltage Data-Acquisition Systems Sample-and-Hold Circuits Communications Circuits

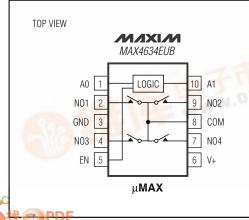
Features

- ♦ Guaranteed RON 2.5 Ω (typ) with 5V Supply 4.5 Ω (typ) with 3V Supply
- ♦ 0.3Ω (max) Guaranteed Ron Match Between Channels
- ♦ 1Ω (max) Guaranteed Ron Flatness Over Signal Range
- ♦ 0.1nA (at +25°C) Guaranteed Low Leakage **Currents**
- ♦ +1.8V to +5.5V Single-Supply Operation
- ♦ +1.8V Operation $R_{ON} = 30\Omega$ (typ) Over Temperature ton = 30ns (typ), toff = 13ns (typ)
- V+ to GND Signal Handling
- ◆ TTL/CMOS-Logic Compatible
- -78dB Crosstalk (at 1MHz)
- -80dB Off-Isolation (at 1MHz)
- 0.018% Total Harmonic Distortion

Ordering Information

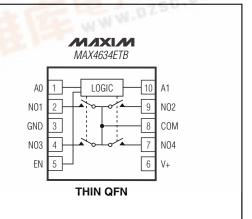
PART	TEMP RANGE	PIN-PACKAGE	TOP MARK
MAX4634EUB	-40°C to +85°C	10 μMAX	_
MAX4634ETB	-40°C to +85°C	10 Thin QFN (3mm x 3mm)	AAU

Pin Configuration/Functional Diagram/Truth Table



MAXIM

	A1	A0	EN	ON SWITCH
5	Х	Х	0	NONE
	0	0	1	1
	0	1	1	2
	1	0	1	3
	1	1	1	4
	- X = Γ	ON'T CA	RF	



Maxim Integrated Products 1

ABSOLUTE MAXIMUM RATINGS

(Voltages referenced to GND)	
V+	0.3V to +6V
A_, EN, COM, NO_ (Note 1)	
Continuous Current (all other pins)	±20mA
Continuous Current (COM, NO_)	±50mA
Peak Current (COM, NO_ pulsed at 1ms,	
10% duty cycle)	±100mA

Continuous Power Dissipation (T _A =	+70°C)
10-Pin µMAX (derate 4.1mW/°C a	bove +70°C)330mW
10-Pin Thin QFN (derate 24.4mW)	/°C
above +70°C)	1951mW
Operating Temperature Range	
MAX4634EUB	40°C to +85°C
Storage Temperature Range	
Lead Temperature (soldering, 10s) .	+300°C

Note 1: Signals on NO_, COM, EN, or A_ exceeding V+ or GND are clamped by internal diodes. Limit forward diode current to maximum current rating.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ELECTRICAL CHARACTERISTICS—Single +5V Supply

 $(V+=+4.5V \text{ to } +5.5V, V_{IH}=2.4V, V_{IL}=0.8V, T_A=-40^{\circ}\text{C} \text{ to } +85^{\circ}\text{C}, \text{ unless otherwise noted.}$ Typical values are at V+ = +5V, T_A=+25^{\circ}\text{C}.) (Notes 2, 9)

PARAMETER	SYMBOL	CON	MIN	TYP	MAX	UNITS		
ANALOG SWITCH	1							
Analog Signal Range	V _{COM} , V _{NO} _			0		V+	V	
On Desistance	D	V+ = 4.5V,	T _A = +25°C		2.5	4	0	
On-Resistance	RON	$I_{COM} = 10 \text{mA},$ $V_{NO} = 0 \text{ to V} +$	TA = TMIN to TMAX			4.5	Ω	
On-Resistance Match	40	V+ = 4.5V,	T _A = +25°C		0.1	0.3		
Between Channels (Notes 3, 8)	ΔRon	$I_{COM} = 10 \text{mA},$ $V_{NO} = 0 \text{ to V} +$	TA = TMIN to TMAX			0.4	Ω	
On-Resistance Flatness (Note 4)	D=: +=(0.1)	V+ = 4.5V,	T _A = +25°C		0.75	1	Ω	
	RFLAT(ON)	$I_{COM} = 10 \text{mA},$ $V_{NO} = 0 \text{ to V} +$	TA = TMIN to TMAX			1.2		
NO Off-Leakage	INO_(OFF)	V+ = 5.5V; VCOM = 1V, 4.5V; VNO_ = 4.5V, 1V	T _A = +25°C	-0.1	±0.01	0.1	nA	
Current (Note 5)			TA = TMIN to TMAX	-0.3		0.3		
COM Off-Leakage Current	leer vees	V+ = 5.5V; V _{COM} = 1V, 4.5V; V _{NO} = 4.5V, 1V	T _A = +25°C	-0.1	±0.01	0.1	nA	
(Note 5)	ICOM(OFF)		TA = TMIN to TMAX	-0.65		0.65	I IIA	
COM On-Leakage Current	loomon	V+ = 5.5V; V _{COM} = 1V, 4.5V;	T _A = +25°C	-0.1	±0.01	0.1	20	
(Note 5)	ICOM(ON)	V_{NO} = 1V, 4.5V, or floating	TA = TMIN to TMAX	-0.65		0.65	- nA	
DIGITAL I/O (A_, EN)		1	'	-1			1	
Input Logic High	VIH			2.4			V	
Input Logic Low	VIL					0.8	V	
Input Logic Current				-100	5	100	nA	

ELECTRICAL CHARACTERISTICS—Single +5V Supply (continued)

 $(V+=+4.5V \text{ to } +5.5V, V_{IH}=2.4V, V_{IL}=0.8V, T_A=-40^{\circ}\text{C} \text{ to } +85^{\circ}\text{C}, \text{ unless otherwise noted.}$ Typical values are at $V+=+5V, T_A=+25^{\circ}\text{C}.)$ (Notes 2, 9)

PARAMETER	SYMBOL	COND	MIN	TYP	MAX	UNITS		
DYNAMIC	1			1				
Turn-On Time (Note 5)	ton	$V_{NO} = 3V$, $R_{I} = 300\Omega$,	T _A = +25°C		14	18	ns	
Tam on time (Note o)	TON	$C_L = 35pF$, Figure 2	TA = TMIN to TMAX			20	113	
Turn-Off Time (Note 5)	toff	$V_{NO} = 3V$, $R_{L} = 300\Omega$,	T _A = +25°C		6	11	ns	
rum-on time (Note 3)	I TOFF	$C_L = 35pF$, Figure 2	$T_A = T_{MIN}$ to T_{MAX}			13	113	
Break-Before-Make Time (Note 5)	tbbm	$V_{NO_{-}} = 3V,$ $R_{1} = 300\Omega.$	T _A = +25°C		8		ns	
	IBBINI	$C_L = 35pF$, Figure 3	$T_A = T_{MIN}$ to T_{MAX}	1				
Charge Injection	Q	V _{GEN} = 2V, R _{GEN} = 0, C _L = 5pF, Figure 4			2		рС	
Off-Isolation (Note 6)	V _{ISO}	$C_L = 5pF$, $R_L = 50\Omega$,	f = 10MHz		-57	dB		
On isolation (Note 0)	V150	Figure 5	f = 1MHz		-80		ab	
Crosstalk (Note 7)	VCT	$C_L = 5pF$, $R_L = 50\Omega$,	f = 10MHz		-52		dB	
Crossiaik (Note 1)	VCI	Figure 5	f = 1MHz		-78		ub	
NO_ Off-Capacitance	CNO_(OFF)	Figure 6			13		pF	
COM Off-Capacitance	CCOM(OFF)	Figure 6			52		рF	
COM On-Capacitance	CCOM(ON)	C _L = 5pF, Figure 6			68		рF	
Total Harmonic Distortion	THD	$R_L = 600\Omega$, $f = 20$ Hz to 20 kHz			0.018		%	
POWER SUPPLY	•						•	
Power-Supply Range	V+			1.8		5.5	V	
Positive Supply Current	I+	$V+ = 5.5V, V_{IH} = V+, V_{IH}$	/IL = 0		0.001	1.0	μΑ	

ELECTRICAL CHARACTERISTICS—Single +3V Supply

 $(V+=+2.7V \text{ to } +3.3V, V_{IH}=2.0V, V_{IL}=0.4V, T_A=-40^{\circ}\text{C} \text{ to } +85^{\circ}\text{C}, \text{ unless otherwise noted.}$ Typical values are at $V+=+3V, T_A=+25^{\circ}\text{C}.)$ (Notes 2, 9)

PARAMETER	SYMBOL	COND	MIN	TYP	MAX	UNITS		
ANALOG SWITCH	•							
Analog Signal Range	V _{COM_} , V _{NO_}			0		V+	V	
On-Resistance	Pou	V+ = 2.7V, ICOM = 10mA, VNO_ = 0 to V+	T _A = +25°C		4.5	7 Ω		
	HOM		TA = TMIN to TMAX			8	_ \	
On-Resistance Match Between Channels	ΔRon	V+ = 2.7V, I _{COM} = 10mA,	T _A = +25°C		0.1	0.3	Ω	
(Notes 3, 8)	ΔιιΟΝ	$V_{NO} = 0$ to V+	TA = TMIN to TMAX			0.4		



ELECTRICAL CHARACTERISTICS—Single +3V Supply (continued)

 $(V+=+2.7V \text{ to } +3.3V, V_{IH}=2.0V, V_{IL}=0.4V, T_A=-40^{\circ}\text{C} \text{ to } +85^{\circ}\text{C}, \text{ unless otherwise noted.}$ Typical values are at $V+=+3V, T_A=+25^{\circ}\text{C}.)$ (Notes 2, 9)

PARAMETER	SYMBOL	CONDITIONS		MIN	TYP	MAX	UNITS	
On-Resistance Flatness	RFLAT(ON)	V+ = 2.7V, I _{COM} = 10mA,	T _A = +25°C		1.2	2.5	Ω	
(Note 4)	TIFLAT(ON)	$V_{NO} = 0$ to V_{+}	$T_A = T_{MIN}$ to T_{MAX}			3	32	
NO_ Off-Leakage Current		V+ = 3.3V; $V_{COM} = 1V, 3V;$	T _A = +25°C	-0.1	±0.01	0.1	nA	
(Note 5)	INO_(OFF)	V _{NO} = 3V, 1V	TA = TMIN to TMAX	-0.3		0.3	11/4	
COM Off-Leakage Current	ICOM (OFF)	V+ = 3.3V; VCOM = 1V, 3V;	T _A = +25°C	-0.1	±0.01	0.1	nA	
(Note 5)	ICOM_(OFF)	$V_{NO} = 3V, 1V$	$T_A = T_{MIN}$ to T_{MAX}	-0.65		0.65		
COM On-Leakage Current	1	V+ = 3.3V; $V_{COM} = 1V, 3V;$	T _A = +25°C	-0.1	±0.01	0.1	^	
(Note 5)	ICOM_(ON)	V _{NO} __ = 1V, 3V, or floating	$T_A = T_{MIN}$ to T_{MAX}	-0.65		0.65	- nA	
DIGITAL I/O (A_, EN)								
Input High	VIH			2.0			V	
Input Low	VIL					0.4	V	
Input Logic Current				-100	5	100	nA	
DYNAMIC	·							
Turn-On Time (Note 5)		V_{NO} = 2V, C_L = 35pF, R_L = 300 Ω , Figure 2	T _A = +25°C		16	22	ns	
rum-on time (Note 3)	TON		TA = TMIN to TMAX			24	1110	
Turn-Off Time (Note 5)	toff	V _{NO} _ = 2V, C _L = 35pF,	T _A = +25°C		8	14	ns	
rum-on time (Note 5)	TOFF	$R_L = 300\Omega$, Figure 2	TA = T _{MIN} to T _{MAX}			16	1 115	
Break-Before-Make Time	t _{BBM}	V _{NO} _ = 2V, C _L = 35pF,	T _A = +25°C		9		ne	
(Note 5)	rBBM	$R_L = 300\Omega$, Figure 3	$T_A = T_{MIN}$ to T_{MAX}	1			- ns	
Charge Injection	Q	V _{GEN} = 1.5V, R _{GEN} = 0	V _{GEN} = 1.5V, R _{GEN} = 0, C _L = 5pF, Figure 4		2		рС	
Off-Isolation (Note 6)	V _{ISO}	$C_L = 5pF, R_L = 50\Omega,$	f = 10MHz		-57		dB	
On Isolation (Note of	V15U	Figure 5	f = 1MHz		-80		_ ub	
Crosstalk (Note 7)	Vст	$C_L = 5pF, R_L = 50\Omega,$	f = 10MHz		-52		dB	
Grossian (Note 1)	٧٥١	Figure 5	f = 1MHz		-78			

ELECTRICAL CHARACTERISTICS—Single +3V Supply (continued)

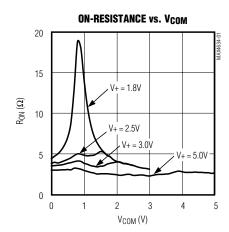
 $(V+=+2.7V \text{ to } +3.3V, V_{IH}=2.0V, V_{IL}=0.4V, T_A=-40^{\circ}C \text{ to } +85^{\circ}C, \text{ unless otherwise noted.}$ Typical values are at $V+=+3V, T_A=+25^{\circ}C.)$ (Note 2)

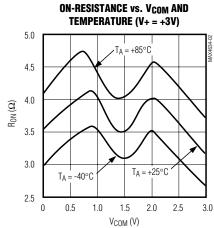
PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS	
NO_ Off-Capacitance	C _{NO_(OFF)}	V _{NO} _ = GND, f = 1MHz, Figure 6		13		pF	
COM Off-Capacitance	CCOM(OFF)	V _{COM} = GND, f = 1MHz, Figure 6		52		pF	
COM On-Capacitance	C _(ON)	V _{COM} = V _{NO} = GND, f = 1MHz, Figure 6		68		pF	
Total Harmonic Distortion	THD	$R_L = 600\Omega$, $f = 20Hz$ to $20kHz$		0.018		%	
POWER SUPPLY	POWER SUPPLY						
Positive Supply Current	l+	$V+ = 3.3V$, $V_{IH} = V+$, $V_{IL} = 0$		0.001	1	μΑ	

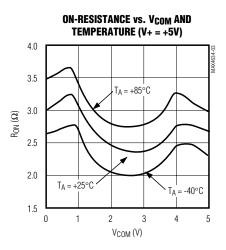
- Note 2: The algebraic convention, where the most negative value is a minimum and the most positive value a maximum, is used in this data sheet.
- **Note 3:** $\Delta R_{ON} = R_{ON(MAX)} R_{ON(MIN)}$.
- **Note 4:** Flatness is defined as the difference between the maximum and minimum value of on-resistance as measured over the specified analog signal ranges.
- Note 5: Guaranteed by design.
- **Note 6:** Off-Isolation = $20\log_{10} (V_{COM} / V_{NO})$, where $V_{COM} = 0$ output and $V_{NO} = 0$ input to off switch.
- Note 7: Between any two switches.
- **Note 8:** RoN and Δ RoN matching specifications for QFN-packaged parts are guaranteed by design.
- Note 9: Thin QFN parts are tested at +25°C and guaranteed by design and correlation over the entire temperature range.

Typical Operating Characteristics

 $(T_A = +25^{\circ}C, unless otherwise noted.)$

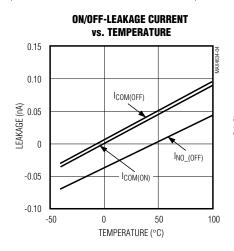


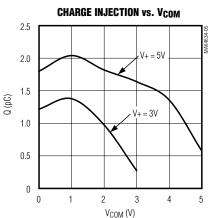


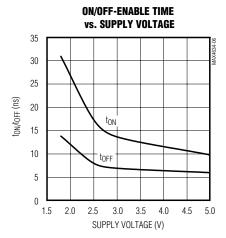


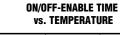
Typical Operating Characteristics (continued)

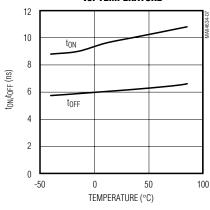
 $(T_A = +25^{\circ}C, \text{ unless otherwise noted.})$



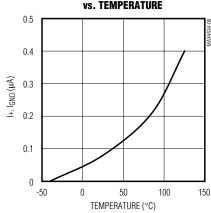




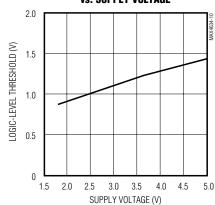




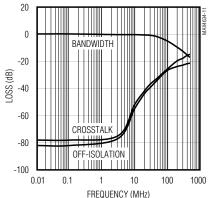




LOGIC-LEVEL THRESHOLD vs. SUPPLY VOLTAGE



FREQUENCY RESPONSE



Pin Description

PIN				
μMAX/ THIN QFN	NAME	FUNCTION		
1	A0	Address Input		
2	NO1	Normally Open Switch 1		
3	GND	Ground		
4	NO3	Normally Open Switch 3		
5	EN	Enable Logic Input		
6	V+	Positive Supply Voltage		
7	NO4	Normally Open Switch 4		
8	COM	Analog Switch Common Terminal		
9	NO2	Normally Open Switch 2		
10	A1	Address Input		

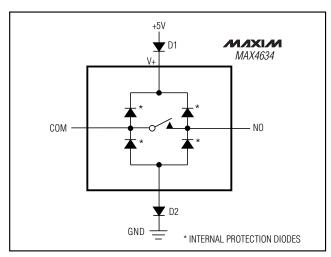


Figure 1. Overvoltage Protection Using External Blocking Diodes

Detailed Description

The MAX4634 is a low-on-resistance, low-voltage analog multiplexer that operates from a +1.8V to +5.5V single supply. CMOS switch construction allows processing of analog signals that are within the supply voltage range (GND to V+).

To disable all switch channels, drive EN low. All four inputs and COM become high impedance during this state. If the disable feature is not needed, connect EN to V+.

Applications Information

Power-Supply Sequencing and Overvoltage Protection

Proper power-supply sequencing is recommended for all CMOS devices. Always apply V+ before applying analog signals or logic inputs, especially if the analog or

logic signals are not current limited. If this sequencing is not possible, and if the analog or logic inputs are not current limited to < 20mA, add a small-signal diode (D1) as shown in Figure 1. If the analog signal can dip below GND, add D2. Adding protection diodes reduces the analog signal range to a diode drop (about 0.7V) below V+ for D1 or to a diode drop above ground for D2. The addition of diodes does not affect leakage. Onresistance increases by a small amount at low supply voltages. Maximum supply voltage (V+) must not exceed 6V.

Protection diodes D1 and D2 also protect against some overvoltage situations. A fault voltage up to the absolute maximum rating at an analog signal input does not damage the device, even if the supply voltage is below the signal voltage.

Test Circuits/Timing Diagrams

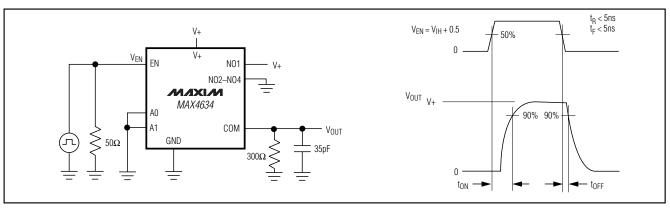


Figure 2. Switching Time

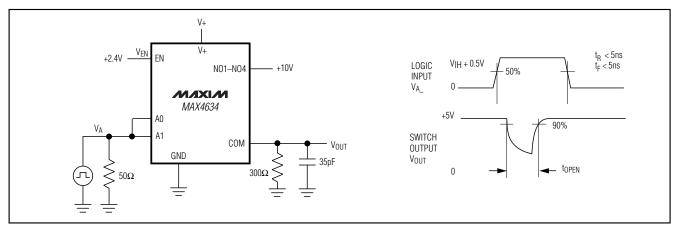


Figure 3. Break-Before-Make Interval

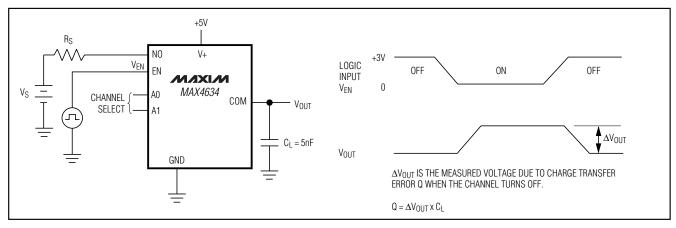


Figure 4. Charge Injection

Test Circuits/Timing Diagrams (continued)

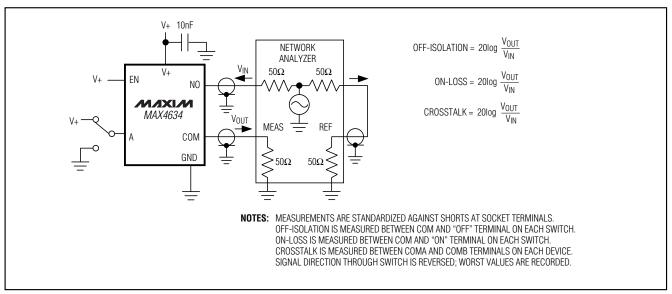


Figure 5. Off-Isolation/On-Channel Bandwidth

CHANNEL SELECT AND COM COM COM F = 1MHz CHANNEL SELECT F = 1MHz

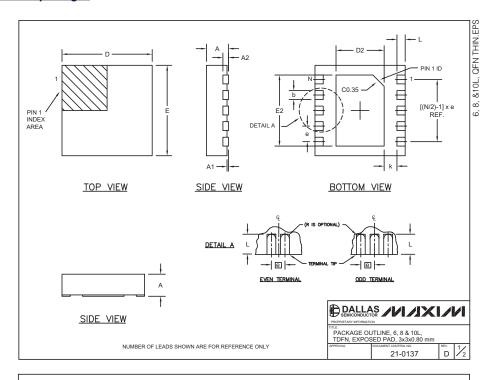
Figure 6. Channel Off/On-Capacitance

Chip Information

TRANSISTOR COUNT: 231

Package Information

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information, go to www.maxim-ic.com/packages



SYMBOL	N DIMEN:	MAX		
A	0.70	0.80		
D	2.90	3.10		
Е	2.90	3.10		
A1	0.00	0.05		
L	0.20	0.40		
k	0.25 MIN.			
A2	0.20 REF.			

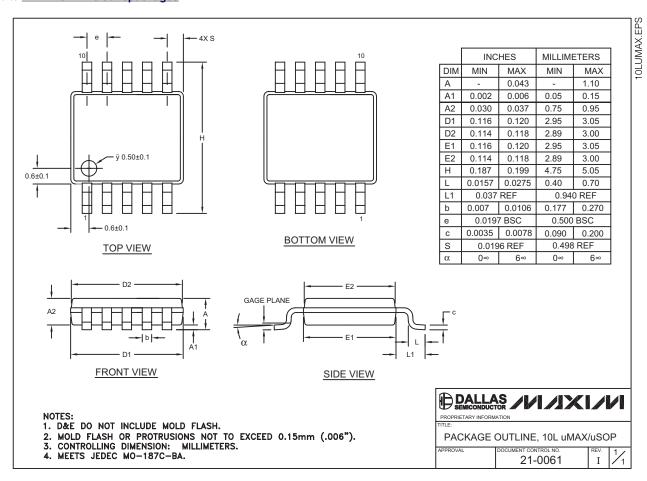
PACKAGE VARIATIONS								
N	D2	E2	е	JEDEC SPEC	b	[(N/2)-1] x e		
6	1.50±0.10	2.30±0.10	0.95 BSC	MO229 / WEEA	0.40±0.05	1.90 REF		
8	1.50±0.10	2.30±0.10	0.65 BSC	MO229 / WEEC	0.30±0.05	1.95 REF		
10	1.50±0.10	2.30±0.10	0.50 BSC	MO229 / WEED-3	0.25±0.05	2.00 REF		
	N 6 8	N D2 6 1.50±0.10 8 1.50±0.10	N D2 E2 6 1.50±0.10 2.30±0.10 8 1.50±0.10 2.30±0.10	N D2 E2 e 6 1.50±0.10 2.30±0.10 0.95 BSC 8 1.50±0.10 2.30±0.10 0.65 BSC	N D2 E2 e JEDEC SPEC 6 1.50±0.10 2.30±0.10 0.95 BSC MO229 / WEEA 8 1.50±0.10 2.30±0.10 0.65 BSC MO229 / WEEC	N D2 E2 e JEDEC SPEC b 6 1.50±0.10 2.30±0.10 0.95 BSC MO229 / WEEA 0.40±0.05 8 1.50±0.10 2.30±0.10 0.65 BSC MO229 / WEEC 0.30±0.05		

- NOTES:
 1. ALL DIMENSIONS ARE IN mm. ANGLES IN DEGREES.
 2. COPLANARITY SHALL NOT EXCEED 0.08 mm.
 3. WARPAGE SHALL NOT EXCEED 0.10 mm.
 4. PACKAGE LENGTH/PACKAGE WIDTH ARE CONSIDERED AS SPECIAL CHARACTERISTIC(S).
 5. DRAWING CONFORMS TO JEDEC MO229, EXCEPT DIMENSIONS "D2" AND "E2".
 6. "N" IS THE TOTAL NUMBER OF LEADS.



Package Information (continued)

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information, go to **www.maxim-ic.com/packages**.



Note: The MAX4634 package does not have an exposed pad.

Maxim cannot assume responsibility for use of any circuitry other than circuitry entirely embodied in a Maxim product. No circuit patent licenses are implied. Maxim reserves the right to change the circuitry and specifications without notice at any time.